

REAL TIME CLOCK MODULE (SPI-Bus)

High-Stability Frequency with Built in Timestamp and **Power Switching**

Compliant

Product Number

RX-4035SA B: X1B000192000100 RX-4035SA AC: X1B000192000200 RX-4035SA AA: X1B000192000300 RX-4035LC B: X1B000202000100 RX-4035LC AC: X1B000202000200 RX-4035LC AA: X1B000202000300



 Interface Type
 Operating voltage range
 Timekeeping voltage range
 Low backup current
 Event detection and Time stamp: 350 nA (SA) 400 nA (LC) / 3 V (Typ.) One-shot full timestamp and interrupt Dual event detection portsAuto power switching functions

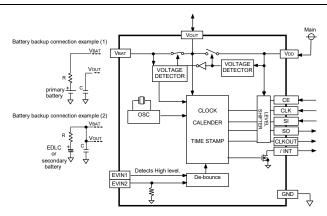
Each terminal has a de-bounce circuit. When VDD deteriorates than 2.4V, internal source is switched to VBAT



RX-4035SA

RX-4035LC

Block diagram



Overview

The event detection and Timestamp function

Dual event detection terminals. Selectable de-bounce time 35ms or 2s. Available event detection interrupt output.

Power switching functions.

- An external diode is unnecessary to have a reverse current prevention switch built-in in the VBAT side to connect a primary cell to.
- When VDD is less than 2.4V, an internal source is switched
- Note: When the supply from VBAT, SPI interface are

Alarm, Periodic interrupt, 32.768kHz clock output.

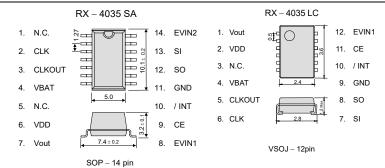
- Available monthly-alarm and weekly-alarm.
- •Interrupt period are selectable from 2Hz to Monthly.
- •CLKOUT outputs 32.768kHz clock powered by VDD

(Unit:mm)

Pin function

| Signal Name | Input / Output | Function |
|----------------|-------------------|--|
| VBAT | | Power supply for backup. |
| Vout | Output | Switched power out. (maximum output current 20mA) |
| CE | Input | SPI chip enable. |
| CLK | Input | SPI serial clock. |
| SO | Output | SPI data out. |
| SI | Input | SPI data in. |
| GND | _ | Ground |
| EVIN1 | Input | Event detection input 1 |
| EVIN2 | Input | Event detection input 2 |
| / INT | Output | Interrupt out. |
| CLKOUT | Output | 32.768kHz output. (CMOS. Can not inhibit.) |
| N.C. | _ | Do not connect. |
| VDD | _ | Main power supply. |

Terminal connection / External dimensions



The metal case inside of the molding compound may be exposed on the top or bottom of this product. This purely cosmetic and does not have any effect on quality, reliability or electrical specs.

Any glue must never use it after soldering LC-package to a circuit board. This product has glass on the back side of a package. When glue invasions between circuit board side and glass side, then glass cracks by thermal expansion of glue. In this case a crystal oscillation stops. Consider glue abolition or glue do not touch to LC-package

Specifications (characteristics)

Recommended Operating Conditions

| - Recommended Operating Conditions | | | | | | | | |
|------------------------------------|---------|------------|------|------|------|------|--|--|
| Item | Symbol | Conditions | Min. | Тур. | Max. | Unit | | |
| Operating voltage | VACCESS | VDD | 2.4 | 3.0 | 5.5 | V | | |
| Time keeping voltage | Vclk | VBAT | 1.0 | 3.0 | 5.5 | V | | |
| Operating temperature | Topr | _ | -40 | +25 | +85 | °C | | |
| Storage temperature | Terc | | -55 | | +125 | °C | | |

■ Frequency characteristics

| - Trequency c | ilai actei | เอเเบอ | | |
|--|--------------|---|---|--------------------|
| Item | Symbol | Conditions | Rating | |
| Frequency tolerance | Δf/f | Ta = +25°C VBAT = 3.0 V | B: 5 ± 23 *1) AA: 5 ± 5 *2) AC: 0 ± 5 *2) | × 10 ⁻⁶ |
| Oscillation start-up time | t sta | Ta = +25 °C V _{DD} = 3.0 V | 1 Max. | s |
| Frequency / voltage characteristics | f/V | T _a = +25 °C V _{DD} = 2.4 V to 5.5 V | ± 1 Max. | × 10 ⁻⁶ |

- *1) Equivalent to ±1 minute of monthly deviation (excluding offset.)
 *2) Equivalent to ±13 seconds of monthly deviation (excluding offset.)

* Refer to application manual for details.

| Current consumption characteristics | | | | Ta= | -40 °C to | +85 °C |
|-------------------------------------|--------|--|------|------|-----------|--------|
| Item | Symbol | Conditions | Min. | Тур. | Max. | Unit |
| Current Consumption | Іват | RX-4035SA VBAT = 3.0V, VDD = 0.0V CE = 0V, CLKOUT = open | | 350 | 1200 | nA · |
| | | RX-4035LC VBAT = 3.0V, VDD = 0.0V CE = 0V, CLKOUT = open | , | 400 | | |
| | IDD | VDD = 3.0V CE = 0V CLKOUT = open | 1 | 1.40 | 2.50 | μA |

| ■ Power supply detection voltage | | | | | -40 °C to | +85 °C |
|---------------------------------------|------------------|------------|-------|------|-----------|--------|
| Item | Symbol | Conditions | Min. | Тур. | Max. | Unit |
| Voltage of low battery detection | VLOW | - | 1.10 | 1.25 | 1.40 | ٧ |
| Power switching voltage (VDD to VBAT) | V _{D2B} | +25 °C | 2.328 | 2.40 | 2.472 | ٧ |

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At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

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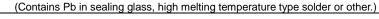
►Pb free.



► Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.





▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

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